

Vishay Siliconix

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
- 20	0.030 at V _{GS} = - 4.5 V	- 12 ^a		
	0.041 at V _{GS} = - 2.5 V	- 12 ^a	15 nC	
	0.056 at V _{GS} = - 1.8 V	- 12 ^a	15110	
	0.150 at V _{GS} = - 1.5 V	- 2		

FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK[®] SC-70 Package

Load Switch, PA Switch and Battery Switch for Portable

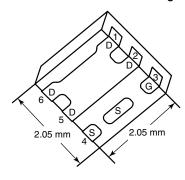
- Small Footprint Area
- Low On-Resistance

APPLICATIONS



RoHS

PowerPAK SC-70-6L-Single



Marking Code Part # code BEX • XXX Lot Traceability and Date code

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Ordering Information: SiA411DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	- 20	V	
Gate-Source Voltage		V_{GS}	± 8		
	T _C = 25 °C		- 12 ^a		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	1_	- 12 ^a	A	
Continuous Diain Current (1) = 130 C)	T _A = 25 °C	I _D	- 8.8 ^{b, c}		
	T _A = 70 °C		- 7 ^{b, c}		
Pulsed Drain Current		I _{DM}	- 20	1	
Continuous Source-Drain Diode Current	T _C = 25 °C	l ₌	- 12 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 2.9 ^{b, c}		
Maximum Power Dissipation	T _C = 25 °C		19		
	T _C = 70 °C	P _D	12	W	
	T _A = 25 °C	' D	3.5 ^{b, c}	VV	
	T _A = 70 °C		2.2 ^{b, c}	1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R_{thJA}	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	5.3	6.5		

Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 80 °C/W.

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SPECIFICATIONS $T_J = 25 ^{\circ}\text{C}$, Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						l	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 19.5		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.3			
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	- 0.4		- 1	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
<u> </u>	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current		V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 55 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α	
On otate Brain ourient	(-)	V _{GS} = - 4.5 V, I _D = - 5.9 A		0.025	0.030	 	
	_	V _{GS} = - 2.5 V, I _D = - 5.0 A		0.033	0.041	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 1.8 V, I _D = - 1.8 A		0.045	0.056		
		V _{GS} = - 1.5 V, I _D = - 0.7 A		0.075	0.150	†	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 5.9 A		21		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1200		pF	
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		210			
Reverse Transfer Capacitance	C _{rss}	20 40		155			
·		V _{DS} = - 10 V, V _{GS} = - 8 V, I _D = - 8.8 A		25	38	nC	
Total Gate Charge	Q_g	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 8.8 A		15	23		
Gate-Source Charge	Q _{gs}			2.5			
Gate-Drain Charge	Q _{gd}			4			
Gate Resistance	R _g	f = 1 MHz		5		Ω	
Turn-On Delay Time	t _{d(on)}			12	20		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_{L} = 1.4 \Omega$		65	100		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -7 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		40	60		
Fall Time	t _f			100	150		
Turn-On Delay Time	t _{d(on)}			5	10	ns	
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_L = 1.4 \Omega$		25	35	1	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -7 \text{ A}, V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$		40	60	- -	
Fall Time	t _f			12	20		
Drain-Source Body Diode Characterist	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 12	Α	
Pulse Diode Forward Current	se Diode Forward Current I _{SM}				20		
Body Diode Voltage	V_{SD}	I _S = -7 A, V _{GS} = 0 V		- 0.85	- 1.2	V	
Body Diode Reverse Recovery Time t _{rr}				20	40	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 7 A, di/dt = 100 A/μs, T _J = 25 °C		10	20	nC	
Reverse Recovery Fall Time	t _a	- 1 1 Λ, αναι – 100 Λ/μο, 1 _J – 20 · 0		13		- ns	
Reverse Recovery Rise Time	t _b		· · · · · · · · · · · · · · · · · · ·	7			

Notes:

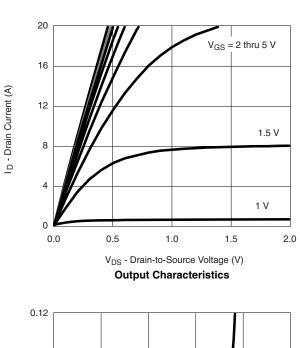
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

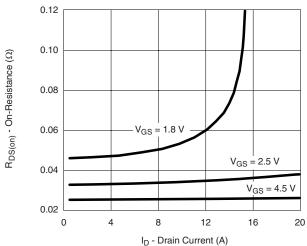
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



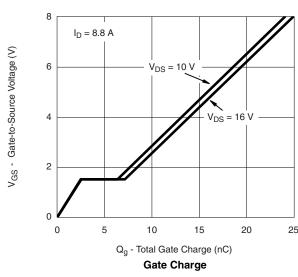
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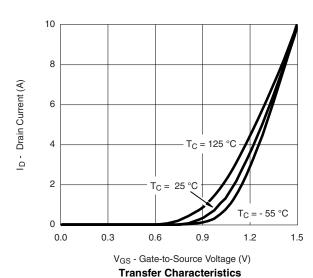
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

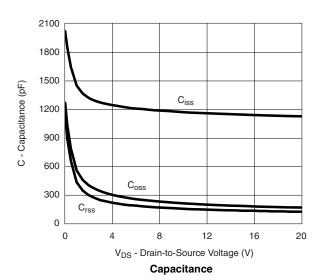


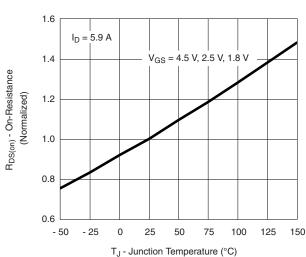










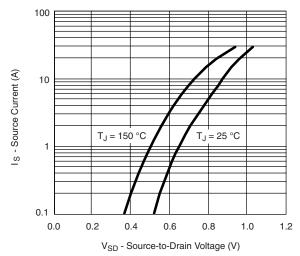


On-Resistance vs. Junction Temperature

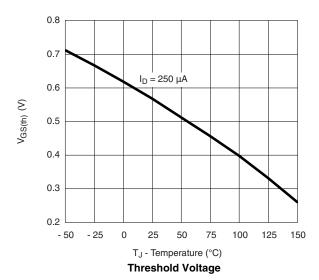
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

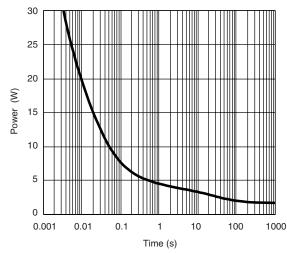


Soure-Drain Diode Forward Voltage

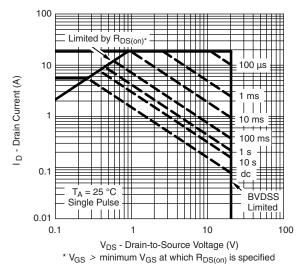


0.12 $I_D = 5.9 A$ $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - On-Resistance (Ω) 0.09 0.06 125 °C 0.03 0.00 0 2 V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage

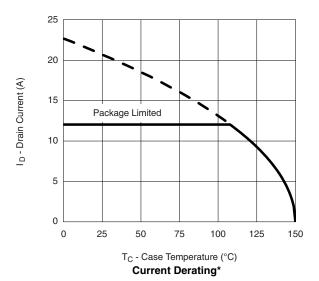


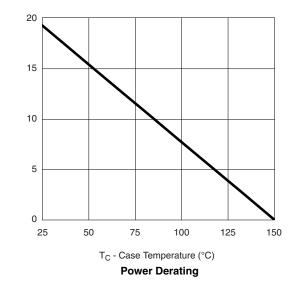
Single Pulse Power, Junction-to-Ambient



Power Dissipation (W)

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





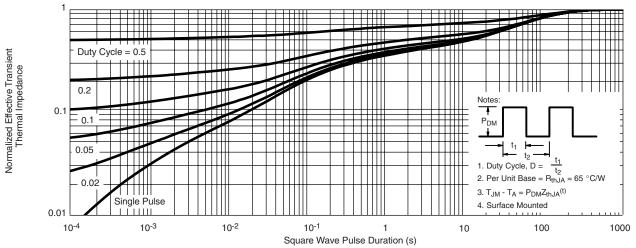
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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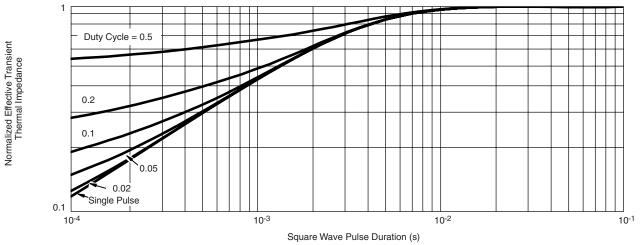
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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